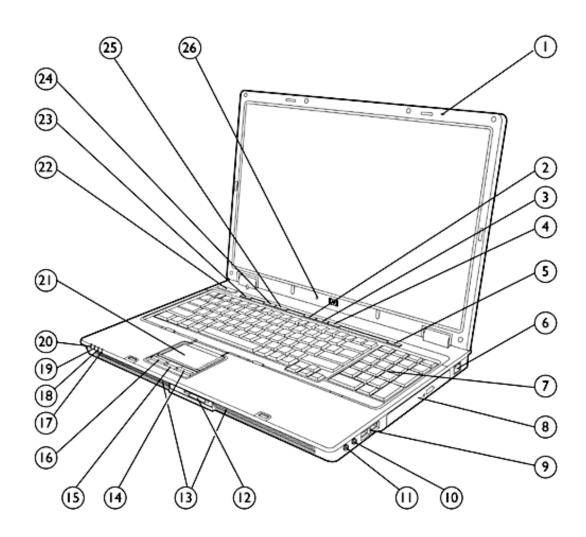
Overview

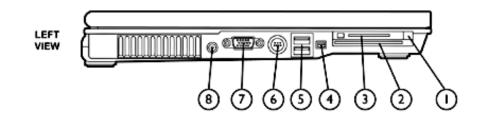


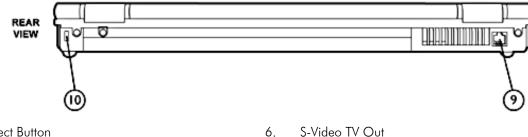
- 1. Internal Microphone
- 2. Volume Mute Button with LED
- 3. Volume Down Button
- 4. Volume Up Button
- 5. Calculator Launch Button
- 6. RJ-45 Port (NIC)
- 7. Integrated Numeric Keypad
- 8. Integrated Optical Drive
- 9. 2 USB 2.0 Ports
- 10. Microphone Jack
- 11. Headphone Jack
- 12. 7-in-1 Media Reader
- 13. Stereo Speakers

- 14. Right Touchpad Button
- 15. Optional Biometric Fingerprint Sensor
- 16. Left Touchpad Button
- 17 Hard Drive Activity LED
- 18 Battery Charging LED
- 19. Power/Standby LED
- 20. Wireless On/Off LED
- 21. Touchpad with scroll zone
- 22. Power Button with LED
- 23. HP Info Center Button
- 24. Wireless On/Off Button with LED
- 25. Presentation Mode Button
- 26. Ambient Light Sensor



Overview





7.

8.

9.

10.

VGA/External Monitor Port

Power Connector

RJ-11 Port (Modem)

Kensington Lock Slot

- 1. PC Card Eject Button
- 2. Integrated Smart Card Reader
- 3. PC Card Slot
- 4. IEEE 1394a Port
- 5. 2 USB 2.0 Ports

At A Glance

- Genuine Windows XP Professional Edition, Genuine Windows XP Home Edition, FreeDOS
- Certified for Novell Linux Desktop 9
- Sleek light-weight design starting at 7.4 lb (3.36 kg) and 1.3 inch (33 mm) thin at front
- 17.0-inch wide screen display
- Intel® Core[™] 2 Duo processors, or Intel Core Duo processors
- Up to 4GB* of 667-MHz DDR2 SDRAM, dual channel memory support
- ATI Mobility Radeon X1600 graphics controller with 256 MB of discrete video memory
- Up to 120-GB 5400 rpm, user-removable hard drive
- Optional 802.11 a/b/g or 802.11 b/g wireless LAN modules and optional Bluetooth®
- IEEE 1394a Port
- 7-in-1 Media Reader
- Security features include integrated Smart Card Reader, TPM Embedded Security Chip, and optional Biometric Fingerprint Sensor
- Broadcom NetXtreme Gigabit Ethernet PCI Express Controller
- Protected by a one-year standard parts and labor warranty certain restrictions and exclusions apply.
- * Intel's numbering system is not a measurement of higher performance.
- ** Above 3-GB, all memory may not be available due to system resource requirements.



Standard Features

Processors	Intel Core 2 Duo Pro Intel Core 2 Duo Pro Intel Core 2 Duo Pro Intel Core Duo proce Intel Core Duo proce Intel Core Duo proce Intel Core Duo proce	bocessor T7400 (2.16-GHz, 667-MHz FSB, 4-MB L2 cache)* bocessor T7200 (2.0-GHz, 667-MHz FSB, 4-MB L2 cache)* bocessor T5600 (1.83-GHz, 667-MHz FSB, 2-MB L2 cache)* bocessor T5500 (1.66-GHz, 667-MHz FSB, 2-MB L2 cache)* bessor T2600* (2.16-GHz, 667-MHz FSB, 2-MB L2 cache) bessor T2500* (2.00-GHz, 667-MHz FSB, 2-MB L2 cache) bessor T2500* (1.83-GHz, 667-MHz FSB, 2-MB L2 cache) bessor T2400* (1.83-GHz, 667-MHz FSB, 2-MB L2 cache) bessor T2300E* (1.66-GHz, 667-MHz FSB, 2-MB L2 cache) bessor T230E* (1.66-GHz, 667-MHz FSB, 2-MB L2 cache) bess
Operating System	Preinstalled	Genuine Windows XP Professional Edition Genuine Windows XP Home Edition FreeDOS
	Supported	Genuine Windows 2000 (drivers downloadable from http://www.hp.com)
	Certified	Novell Linux Desktop 9
Chipset	Mobile Intel 945PM	Express Chipset with 667-MHz front side bus
Graphics	ATI Mobility Radeon	X1600 graphics controller with 256 MB of discrete video memory
Display	Internal	17.0-inch WXGA+ display with 1440 x 900 resolution and 16M colors 17.0-inch WSXGA+ wide viewing angle BrightView display with 1680 x 1050 resolution and 16M colors Ambient light sensor
	External	Up to 32-bit per pixel color depth VGA port supports resolutions up to 2048 x 1536 at 75 Hz, and lower resolutions at up to 100 Hz DVI port in optional HP Docking Station (sold separately) supports resolutions up to 1600 x 1200 at both full and reduced blanking, and 1920 x 1200 at reduced blanking NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.



Standard Features

Memory	Standard	512-MB, 1024-MB or 2048-MB 667-MHz DDR2 SDRAM SODIMMs Two SODIMM slots supporting dual channel memory
	Maximum	Upgradeable to 4096-MB maximum (2048-MB SODIMM in slots 1 and 2)
	Dual-channel	Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.
	HP branded memory to er	dustry standard nature of some third-party memory modules, we recommend usure compatibility. If you mix memory speeds, the system will perform at the we 3-GB, all memory may not be available due to system resource
Communications	Integrated Broadcom Net> Smart Power NIC technolo	Ktreme Gigabit Ethernet PCI Express Controller (10/100/1000 NIC*) with HP
	56K V.92 modem** with a	ligital line guard
	Gigabit Ethernet, and doe transmission, connection t	" or "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for s not connote actual operating speed of 1 Gb/sec. For high speed o a Gigabit Ethernet server and network infrastructure is required.
		s from 56K modem compliant sources. Maximum achievable download y do not reach 56 KB/s, and will vary with line conditions. Modem availability atory approval.
Wireless Devices	industry standards. Integra	e of secure, integrated wireless LAN options featuring support for the latest ted Bluetooth is also an option (factory configurable only) and can be the supported wireless LAN options.
	All integrated wireless LAN options	Wi-Fi certified Cisco Compatible Extensions support (Version 4.0) Wired Equivalent Privacy (WEP) support up to 128-bit keys Wi-Fi Protected Access (WPA) and WPA2 support 802.1x authentication support, including EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, and LEAP Advanced Encryption Standard (AES) support WiFi Certified for WPA2, WMM Dual antennas integrated in the display enclosure
	Intel PRO/Wireless 3945ABG Network Connection	Intel Centrino mobile technology Integrated support for 802.11a, b and g Up to 54-mbps data rate
	Intel PRO/Wireless 3945BG Network Connection	Intel Centrino mobile technology Integrated support for 802.11 b and g Up to 54-mbps data rate
	Broadcom 4311AG WiFi Adapter	
	Broadcom 4311BG WiFi Adapter	
		Bluetooth Specification v2.0 compliant



Standard Features		
Keyboard	keyboard features such a 12 function keys. Other fe conservation, brightness,	tible keyboard features an industry standard, full-width layout with desktop s isolated inverted-T cursor control keys, left and right control and alt keys, and eatures include a full numeric keypad, hotkeys for instant access to power and other features, 19.05 mm x 19.05 mm key pitch (center-to-center comfort-dished keycaps, and bright key legends for improved visibility in low
One-Touch Productivity Buttons		to the following features: HP Info Center, Wireless On/Off, Presentation ume up, Volume Mute, and Calculator Launch.
Pointing Device	Touchpad with scroll zone	e, two soft-touch pick buttons
Expansion Card Slots	One Type I/II PC Card slot	Supports 32-bit CardBus and 16-bit PC Cards
	One Integrated Smart Card Reader	Compatible with ISO 7816 compliant Smart Cards PC/SC interface support
Media Slots	7-in-1 Media Reader	Supports SD (Secure Digital), MMC (MultiMedia Card), Memory Stick, Memory Stick Pro, Memory Stick Duo*, Smart Media, xD-Picture card
		to Adapters are required and sold separately. Inserting a Memory Stick Duo tebook could damage the memory card and/or notebook.
Storage	Hard Drives	60-, 80-, 100-, 120-GB 5400 rpm SMART SATA
		are customer removable and will withstand multiple insertion/removal cycles. r the system recovery software.
	HP Mobile Data Protection System 3D	Hard drive is mounted directly to the notebook frame, reducing the transmission of shock to the hard drive. Uses three-axis digital motion detection with intelligent sensitivity to help protect the hard drive during normal use from shock and vibration.
	Fixed Optical Drives	DVD/CD-RW Combo DVD+/-RW SuperMulti with Double Layer LightScribe DVD+/-RW with Double Layer



HP Compaq nx9420 Notebook PC

Standard Features		
Interfaces	PC Card Slot	One – Type I/II
	Smart Card Reader	One
	External Monitor	One – VGA
	External Microphone	One
	Headphone/Line out	One
	Power Connector	One
	RJ-11 (Modem)	One
	RJ-45 (NIC)	One
	Ambient Light Sensor	One
	IEEE 1394a Port (4-pin)	One
	S-Video TV Out	One (Support for NTSC/PAL)
	USB 2.0	Four
	Docking Connector	One
	Accessory Battery Connector	One
	LED Status Indicators	Twelve
	Stereo headphone/line ou Stereo microphone in	ne down, and mute buttons It
Software	Preinstalled Software Microsoft Windows XP	Adobe Acrobat Reader HP Backup and Recovery Manager HP Help and Support HP Mobile Print Driver HP ProtectTools Security Manager: BIOS Configuration for HP ProtectTools Embedded Security for HP ProtectTools Credential Manager for HP ProtectTools HP Quick Launch Buttons HP Wireless Assistant Sonic Digital Media Plus: RecordNow! (for optional DVD+/-RW and DVD/CDRW drives) MyDVD (DVD Authoring for optional DVD+/-RW drives) Synaptics Touchpad Driver Symantec Norton Internet Security with complimentary 60-day live update Intervideo WinDVD – DVD Player (for optional DVD+/-RW, DVD/CDRW and DVD drives)
	Additional software available from the Web	Smart Card Security for HP ProtectTools Device Access Manager for HP ProtectTools



Standard Features			
HP Backup and Recovery Manager	provide data and system becomes corrupted or if i Manager can perform sc Up to 8 GB is reserved for	file protection for HP busines important information is accion heduled or manual backups	anager. HP Backup and Recovery Manager can s PCs to enable fast recovery if the system dentally deleted. HP Backup and Recovery of the entire drive or individual files and folders. re. HP Backup and Recovery Manager can also nal hardware).
SMBIOS Version 2.4	System Management BIC information.	DS, previously known as DMI	BIOS, is used to store system management
HP ProtectTools Security Manager	ProtectTools Security Mar capabilities through add- - Smart Card Secu - BIOS Configurati - Embedded Secur - Credential Mana	nager is an extensible client s	orm for business notebooks and desktops. The HP ecurity console that delivers enhanced security es currently available or planned are:
Security	Standard Features	HP ProtectTools Security N Configuration Control Ha Memory Change Alert Ownership Tag Setup Password Power-On Password DriveLock TPM Enhanced DriveLock HP Disk Sanitizer Kensington Lock Slot Support for Computrace / separately)	
		Integrated Smart Card Reader	Compatible with ISO 7816 compliant Smart Cards PC/SC interface support
		TPM 1.2 Embedded Security Chip	Designed to the Trusted Computing Group (TCG) standard Microsoft Crypto API and PKCS#11 software interface support RSA Secured Partner program certification NOTE: Full functionality of the TPM Embedded Security Chip is available only with Windows XP Professional.
	Optional Features	HP Biometric Fingerprint Sensor	Biometric sensor for fingerprint authentication, configurable between Touchpad pick buttons
	For more information on	HP security solutions refer to	http://www.hp.com/go/security.



Power Supply	External 90 watt AC ada	nter 6 fact (1.9 mater) never card included
Power Supply		pter, 6-foot (1.8-meter) power cord included. ternal AC adapter is 12 feet (3.66 meter). ogy*
*Fast Charge Technolog not apply to 12-cell Ultr		to 90% within 90 minutes when the system is off. Fast Charge Technology does
Battery	Primary Battery	69Wh 8-cell high capacity Lithium-Ion
	Optional HP 8-Cell Extended Life Battery	52Wh 8-cell high capacity Lithium-Ion
	Optional HP 12-Cell Ultra-Capacity Battery	95Wh 12-cell high capacity Lithium-Ion
Battery Life		69Wh 8-cell Primary
	Primary Battery	Up to 4 hours
	Primary Battery and optional HP 8-Cell Extended Life Battery	Up to 7 hours and 30 minutes
	Primary Battery and optional HP 12-Cell Ultra-Capacity Battery	Up to 10 hours
	on the product, power m	ary depending on the product configuration, product model, applications loaded anagement settings of the product, and the product features used by the teries, the maximum capacity of this battery will decrease with time and usage.
System Standby Time	Up to 2 weeks	
Power Conservation		SpeedStep technology with Intel Core Duo processors (allows Battery Optimized nance Mode, or Automatic mode)
	HP Smart Power NIC tec	hnology
	ATI PowerPlay technolog	у
	Hibernation	
	Standby	
	ACPI compliance	
Docking	HP Docking Station HP Advanced Docking St	tation
	Features include Gigabit S-video TV out, USB 2.0	itions provide simple and convenient port replication and cable management. NIC pass through, modem pass through, legacy parallel and serial ports, DVI, ports, integrated security mechanism [*] , integrated MultiBay II and ExpressCard [*] tions are compatible across multiple Business Notebook platforms enabling a ship.
	 * HP/Kensington Cable ** HP Advanced Docking 	e Lock required (purchased separately) a Station only



Standard Features

Service and Support

HP Services includes a one-year standard parts and labor warranty, pick-up or carry-in, and toll-free 7 x 24 hardware technical phone support (depending on model). On-site service and warranty upgrades are also available.

NOTE: Certain restrictions and exclusions apply. Consult the HP Customer Support Center for details. http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp.



Options

Memory	512-MB 667-MHz DDR2 SDRAM	ЕМ993АА
	1-GB 667-MHz DDR2 SDRAM	EM994AA
	2-GB 667-MHz DDR2 SDRAM	EM995AA
MultiBay II Storage	DVD-ROM MultiBay II Drive	PA849A
(9.5-mm)	Combo DVD/CD-RW MultiBay II Drive	PA850A
NOTE: Requires HP Advanced Docking Station	DVD+/-RW SuperMulti with Double Layer MultiBay II Drive	PA851A
or HP External MultiBay II	80-GB 5400 rpm MultiBay II Hard Drive	PH357A
Other Storage	HP 80-GB 5400 rpm Primary SATA Hard Drive	ET354AA
5	HP SuperMulti (DL) DVD+/-RW LightScribe Drive	ET353AA
	HP USB Digital Drive + 256-MB Secure Digital Card	DL702AA
	HP USB Diskette Drive	DC361B
Communications	Intel PRO/Wireless 3945ABG 802.11 a/b/g WLAN option kit	EX150AA#xxx
Expansion Solutions	HP Docking Station	EN488AA#xxx
	HP Advanced Docking Station	EN489AA#xxx
	HP Monitor Stand	PA507A
	HP Adjustable Notebook Stand	PA508A
	HP External MultiBay II (9.5-mm)	PA509A#xxx
	HP 4-port USB 2.0 Hub	DG954A
Power	HP 2-bay Battery Charging Station	DT533A#xxx
	HP 10-bay Battery Charging Station (North America only)	DT534A#ABA
	Battery Adapter kit #1	PK402A
	90W Smart AC Adapter	ED495AA#xxx
	90W Smart Auto Adapter	ED493AA
	65W Air/Auto/AC Combo Adapter	ED993AA#xxx
	Primary 8-cell Battery Pack	PB992A
	HP 8-cell Extended Life Battery	PB993A
	HP 12-cell Ultra-Capacity Battery	EJ092AA
Carrying Cases	HP Executive Leather Case	PA847A
	HP Sport Backpack	DG102A
Security	HP/Kensington Cable Lock	PC766A



Options

Input/Output Devices

USB/PS2 Keyboard USB/PS2 Optical Mouse HP USB Optical Travel Mouse

DC852A#xxx DC369A F2100A



Memory

Up to 4096 MB* of 667-MHz DDR2 SDRAM Two DIMM slots DIMM sizes supported: 512 MB, 1024 MB, and 2048 MB

Standard Memory	512 N	1B (512 MB x 1)
	1024	MB (1024 MB x 1 or 512 MB x 2)
	2048	MB (1024 MB x 2)
	4096	MB* (2048 MB x 2)

Optional Memory Upgrades

Support for up to 4096 MB* of memory is available (with the installation of optional DDR2 SDRAM memory kits). Both memory slots are user accessible. Please refer to the Hardware and Software Guide for installation procedures. Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

Up to	Slot 1	Slot 2
1024 MB	1024 MB	Empty
1024 MB	512 MB	512 MB
1536 MB	1024 MB	512 MB
2048 MB	1024 MB	1024 MB
4096 MB*	2048 MB	2048 MB

NOTE: This chart does not represent all possible memory configurations. Due to the non-industry standard nature of some third-party memory modules, we strongly recommend using only HP branded memory modules to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

Memory Upgrades	512-MB 667-MHz DDR2 SDRAM	EM993AA
	1024-MB 667-MHz DDR2 SDRAM	EM994AA
	2048-MB 667-MHz DDR2 SDRAM	EM995AA

* Above 3-GB, all memory may not be available due to system resource requirements.



Storage

Removable Media Drive Support

LightScribe DVD+/-RW Drive with Double Layer	Quantity Supported One	Drive Bay Fixed optical drive bay
DVD+/-RW SuperMulti Drive with Double Layer	One	Fixed optical drive bay
DVD/CD-RW Combo Drive	One	Fixed optical drive bay

Hard Drive Support

	Quantity Supported	Drive Bay
Primary Hard Drives		
120-GB 5400 rpm SMART SATA Hard Drive	One	Dedicated hard drive bay
100-GB 5400 rpm SMART SATA Hard Drive	One	Dedicated hard drive bay
80-GB 5400 rpm SMART SATA Hard Drive	One	Dedicated hard drive bay
60-GB 5400 rpm SMART SATA Hard Drive	One	Dedicated hard drive bay



Weight 7.4 lb (3.36 kg) NOTE: Height varies depending upon where on the notebook file measurement is made. Weight includes 8-cell between, 60-GB that drive, 512-MB memory, 802.11 wireless communications module, and TPM Embedded Security Chip. Weight varies by configuration and components. Stand-Alone Power Requirements Nominal Operating Valeoge 19 V Average Operating Power Valeoge 250 V Temperature Operating Operating 32° to 95° F (0° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (not 95° C) 41° to 95° to 95° (5° to 50° C) (0° to 40° C) Relative Humidity Operating 0perating 125° G (2° ms, half-sine Non-operating 40° to 95° to 10,000 ff (-15.24 to 12,192 m) Mittade Operating 0perating 50 to 10,0000 ff (-15.24 to 12,192 m) Mittade No No Certifica	System Unit	Dimensions (HxWxD)	1.3 in (at front) x 15.5 in x	x 10.8 in (33 mm (at front) x 393 mm x 275 mm)	
includes 0-cell battery, 60-GB hard drive, 512-MB memory, 802-11 wices communications module, and TPM Embedded Security Chip. Weight varies by configuration and components. Stand-Alone Power Requirements Nominal Operating Voltage 19 V Avarage Operating Power 49 W Max Operating Power <90 W Temperature Operating Non-operating 32° to 95° F (5' to 35° C) (not writing optical) A1° to 95° F (5' to 35° C) (writing optical) A1° to 95° F (5' to 35° C) (writing optical) A1° to 95° F (5' to 35° C) (writing optical) A1° to 95° F (5' to 35° C) (writing optical) A1° to 95° F (5' to 35° C) (writing optical) A1° to 95° F (5' to 35° C) (writing optical) A1° to 95° F (5' to 35° C) (writing optical) A1° to 95° F (5' to 35° C) (writing optical) A1° to 95° F (5' to 35° C) (writing optical) A1° to 95° F (5' to 35° C) (writing optical) Non-operating Non-operating 05% to 95%, 101.65° F (5' to 35° C) (writing optical) A1° to 90%, non-condensing Non-operating 125 G, 2 rns, half-sine Non-operating 0.50 to 10,000 ft (-15.24 to 3,048 m) Non-operating .50 to 40,000 ft (-15.24 to 12,192 m) Industry Standard Ulu Yas Certifications Ulu Yas Citations Ulu Yas Citations Ulu Yas Citations Ulu Yas Citatio /NZ A-Tick Yas Yas <th></th> <th>Weight</th> <th></th> <th></th>		Weight			
Requirements Voltage Average Operating Power < 90 W Max Operating Power < 90 W Temperature 2° to 95° F (0° to 35° C) (not writing optical) At* to 95° F (5° to 35° C) (writing optical) 41° to 95° F (5° to 35° C) (writing optical) At* to 95° F (5° to 35° C) (writing optical) 41° to 95° F (5° to 35° C) (writing optical) Relative Humidity Operating 4° to 140° F (20° to 60° C) Non-operating 10% to 90%, non-concensing Non-soperating Shock Operating 125 G, 2 ms, holf-sine Non-operating 0.75 grms Non-operating Non-operating .50 to 10.000 ff (-15.24 to 3.048 m) (unpressurized) Non-operating .50 to 10.000 ff (-15.24 to 3.048 m) (unpressurized) Non-operating .50 to 10.000 ff (-15.24 to 3.048 m) (unpressurized) Non-operating .50 to 10.000 ff (-15.24 to 3.048 m) (unpressurized) Non-operating .50 to 10.000 ff (-15.24 to 3.048 m) (unpressurized) Non-operating .50 to 10.000 ff (-15.24 to 3.048 m) (unpressurized) Non (-0 XS) Yes Cefifications		includes 8-cell battery, 60-GB hard drive, 512-MB memory, 802.11 wireless communications module,			
Max Operating Power < 90 W Temperature Operating 32° to 95° F (0° to 35° C) (writing optical) H ¹ to 95° F (0° to 35° C) (writing optical) Non-operating -4% to 140° F (-20° to 60° C) Relative Humidity Operating 10% to 95%, 101.6° F (38.7° C) maximum wet builts temperature Shock Operating 200 G, 2 ms, holf-sine Non-operating 200 G, 2 ms, holf-sine Non-operating 0.75 grms Non-operating 0.50 to 10,0000 f (-15.24 to 3,048 m) (unpressurized) Non-operating -50 to 10,0000 f (-15.24 to 3,048 m) (unpressurized) Non-operating -50 to 10,0000 f (-15.24 to 3,048 m) (unpressurized) Non-operating -50 to 10,0000 f (-15.24 to 3,048 m) (unpressurized) Non-operating -50 to 10,0000 f (-15.24 to 3,048 m) (unpressurized) Non-operating -50 to 10,0000 f (-15.24 to 3,048 m) (unpressurized) Non-operating -50 to 10,0000 f (-15.24 to 3,048 m) (unpressurized) Non-operating -50 to 10,0000 f (-15.24 to 3,048 m) (unpressurized) Non-operating -50 to 10,0000 f (-15.24 to 3,048 m) (CES Sol				19 V	
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Relative HumidityOperating10% to 90%, non-condensing 5% to 95%, 101.6° F (38.7° C) maximum wet bublis temperature bublis temperatureShockOperating220 G, 2 ms, half-sine Non-operating200 G, 2 ms, half-sineRandom VibrationOperating0.75 grmsAltitude (unpressurized)Operating-50 to 10,000 ft (-15.24 to 3,048 m) Non-operating-50 to 40,000 ft (-15.24 to 12,192 m)Industry Standard CertificationsBlue AngelVesCSAYesYesCSAYesCSAYesCSAYesCSAYesCSAYesCSAYesCSAYesCCCYesDapper VCCI Compliance BSMIYesCCCYesBSMIYesCCCYesBSMIYesCCCYesBSMIYesCOC TYesBORI or BEUS (CTT) GOSTYesStadi rabian Compliance (ICCP)Yes				41° to 95° F (5° to 35° C) (writing optical)	
Non-operating5% to 95%, 101.6° F (38.7° C) maximum wet bublis temperatureShockOperating125 G, 2 ms, half-sineNon-operating0.75 grmsRandom VibrationOperating1.50 grmsNon-operating-50 to 10,000 ff (-15.24 to 3,048 m)(unpressurized)Non-operating-50 to 40,000 ff (-15.24 to 12,192 m)Industry Standard CertificationsBlue AngelNoULYesSameEnergy Star Compliant (CCCYesICESYesGSYesAustralia / NZ A-Tick ComplianceYesCCCYesJapan VCCI Compliance BSMIYesCCCYesBMIYesCCCYesBSMIYesCCCYesBSMIYesCCCYesBSMIYesCCCYesBSMIYesCCCYesBSMIYesCE Marking Compliance (CTI) GOSTYesSaudi Arabian Compliance (ICCP)Yes			Non-operating	-4° to 140° F (-20° to 60° C)	
Shock Operating 125 G, 2 ms, half-sine Non-operating 200 G, 2 ms, half-sine Random Vibration 0.075 grms Non-operating 1.50 grms Altitude Operating -50 to 10,000 ff (-15.24 to 3,048 m) (unpressurized) Non-operating -50 to 40,000 ff (-15.24 to 12,192 m) Industry Standard Blue Angel No Certifications UL Yes ICES Ves Scala ICES Ves Scala Australia / NZ A-Tick Yes Scala Compliance CCC Yes Japan VCCI Compliance Yes BSMI Yes BSMI Yes CTO BELUS Yes BNCI or BELUS Yes GOST Yes GOST Yes GOST Yes Saudi Arabian Yes		Relative Humidity	Operating	10% to 90%, non-condensing	
Non-operating200 G, 2 ms, half-sineRandom VibrationOperating0.75 grmsAltitudeOperating1.50 grmsAltitudeOperating-50 to 10,000 ft (-15.24 to 3,048 m)(unpressurized)Non-operating-50 to 40,000 ft (-15.24 to 12,192 m)Industry StandardBlue AngelNoCertificationsULYesEnergy Star CompliantYesCSAYesICESYesGSYesJapan VCCI ComplianceYesJapan VCCI ComplianceYesBSMIYesCE Marking ComplianceYesICESYesJapan VCCI ComplianceYesGS MIYesCCCYesJapan VCCI ComplianceYesGOSTYesGOSTYesGOSTYesSaudi ArabianYesCompliance (ICCP)Yes			Non-operating		
Random VibrationOperating0.75 grmsNon-operating1.50 grmsAltitude (unpressurized)Operating-50 to 10,000 ft (-15.24 to 3,048 m)Non-operating-50 to 40,000 ft (-15.24 to 12,192 m)Industry Standard CertificationsBlue AngelNoULYesEnergy Star CompliantYesICESYesICESYesGSYesComplianceYesCCCYesJapan VCCI ComplianceYesISMIYesECE Marking ComplianceYesCC Marking ComplianceYesISMIYesCE Marking ComplianceYesCoratian ComplianceYesCoratian ComplianceYesCOT BELUSYesCoratian ComplianceYesCoratian ComplianceYes <tr< th=""><th></th><th>Shock</th><th>Operating</th><th>125 G, 2 ms, half-sine</th></tr<>		Shock	Operating	125 G, 2 ms, half-sine	
Non-operating1.50 grmsAltitude (unpressurized)Operating-50 to 10,000 ft (-15.24 to 3,048 m)Industry Standard CertificationsBlue AngelNoIndustry Standard CertificationsBlue AngelNoULYesEnergy Star CompliantYesCSAYesICESYesGSYesCCCYesJapan VCCI ComplianceYesData VCCI ComplianceYesDistrict ComplianceYesCCCYesJapan VCCI ComplianceYesCCCYesDistrict ComplianceYesCCCYesJapan VCCI ComplianceYesCCCYesDistrict ComplianceYesCCCYesJapan VCCI or DistrictYesComplianceYesCCI or DistrictYesGOSTYesGOSTYesSaudi Arabian Compliance (ICCP)Yes			Non-operating	200 G, 2 ms, half-sine	
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(unpressurized)Non-operating-50 to 40,000 ft (-15.24 to 12,192 m)Industry Standard CertificationsBlue AngelNoULYesEnergy Star CompliantYesCSAYesICESYesGSYesAustralia / NZ A-Tick ComplianceYesCCCYesJapan VCCI ComplianceYesBSMIYesCE Marking ComplianceYesCC marking ComplianceYesCCTYesBSMIYesCE Marking ComplianceYesCCTYesBNCI or BELUSYesCOSTYesSaudi Arabian Compliance (ICCP)Yes			Non-operating	1.50 grms	
Industry Standard Certifications Blue Angel UL Energy Star Compliant CSA ICES GS GS GS Australia / NZ A-Tick GS CCC CCC CCC Sa Japan VCCI Compliance CCC CCC Sa Japan VCCI Compliance CCC Sa Japan VCCI Compliance CCC CCC Sa Japan VCCI Compliance CCC Sa Japan VCCI COMPLIAN Sa Japan VCCI COMPLIAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN SA JAPAN			Operating	-50 to 10,000 ft (-15.24 to 3,048 m)	
CertificationsULYesEnergy Star CompliantYesCSAYesICESYesICESYesAustralia / NZ A-Tick ComplianceYesCCCYesJapan VCCI ComplianceYesMICYesBSMIYesCE Marking ComplianceYesICE Marking ComplianceYesGOSTYesGaudi Arabian Compliance (ICCP)Yes		(unpressurized)	Non-operating	-50 to 40,000 ft (-15.24 to 12,192 m)	
CLTesEnergy Star CompliantYesCSAYesICESYesGSYesAustralia / NZ A-Tick ComplianceYesCCCYesJapan VCCI ComplianceYesMICYesBSMIYesCE Marking ComplianceYesBNCI or BELUSYesCroatian Compliance (CIT)YesGOSTYesSaudi Arabian Compliance (ICCP)Yes		-	Blue Angel	No	
CSAYesICESYesGSYesAustralia / NZ A-Tick ComplianceYesCCCYesJapan VCCI ComplianceYesMICYesBSMIYesCE Marking ComplianceYesDNCI or BELUSYesCroatian Compliance (CIT)YesGOSTYesSaudi Arabian Compliance (ICCP)Yes		Certifications	UL	Yes	
ICESYesGSYesAustralia / NZ A-Tick ComplianceYesCCCYesJapan VCCI ComplianceYesMICYesBSMIYesCE Marking ComplianceYesBNCI or BELUSYesGOSTYesSaudi Arabian Compliance (ICCP)Yes			Energy Star Compliant	Yes	
GSYesAustralia / NZ A-Tick ComplianceYesCCCYesJapan VCCI ComplianceYesMICYesBSMIYesCE Marking ComplianceYesBNCI or BELUSYesCroatian Compliance (CIT)YesGOSTYesSaudi Arabian Compliance (ICCP)Yes			CSA	Yes	
Australia / NZ A-Tick ComplianceYesCCCYesJapan VCCI ComplianceYesMICYesBSMIYesCE Marking ComplianceYesBNCI or BELUSYesCroatian Compliance (CIT)YesGOSTYesSaudi Arabian Compliance (ICCP)Yes				Yes	
ComplianceCCCYesJapan VCCI ComplianceYesMICYesBSMIYesCE Marking ComplianceYesBNCI or BELUSYesCroatian ComplianceYesGOSTYesSaudi Arabian Compliance (ICCP)Yes			GS	Yes	
Japan VCCI ComplianceYesMICYesBSMIYesCE Marking ComplianceYesBNCI or BELUSYesCroatian ComplianceYesGOSTYesSaudi Arabian Compliance (ICCP)Yes				Yes	
MIC Yes BSMI Yes CE Marking Compliance Yes BNCI or BELUS Yes Croatian Compliance Yes (CIT) GOST Yes Saudi Arabian Yes Compliance (ICCP)					
BSMIYesCE Marking ComplianceYesBNCI or BELUSYesCroatian Compliance (CIT)YesGOSTYesSaudi Arabian Compliance (ICCP)Yes				Yes	
CE Marking Compliance Yes BNCI or BELUS Yes Croatian Compliance Yes (CIT) GOST Yes Saudi Arabian Yes Compliance (ICCP)					
BNCI or BELUS Yes Croatian Compliance Yes (CIT) GOST Yes Saudi Arabian Yes Compliance (ICCP)				Yes	
Croatian Compliance Yes (CIT) GOST Yes Saudi Arabian Yes Compliance (ICCP)					
(CIT) GOST Yes Saudi Arabian Yes Compliance (ICCP)					
Saudi Arabian Yes Compliance (ICCP)				Yes	
Compliance (ICCP)					
SABS Yes				Yes	
			SABS	Yes	



Technical Specificat	tions		
HP 90W Smart AC Adapter	Dimensions Weight Input	5.24 x 2.28 x 1.1 in (13.3 0.86 lb (390 g) 100 to 240 VAC	3 x 5.8 x 2.9 cm)
		Input Efficiency	83% min at 115 VAC
		Input frequency range	47 to 63 Hz
		Input AC current	1.5 A at 90 VAC, 0.75 A at 180 VAC PFC Version
			2.4 A at 90 VAC, 1.2 A at 180 VAC NON PFC Version
	Output	Output power 65W	90W
		DC output	18.5V
		Hold-up time	5 msec at 115 VAC input
		Output current limit	<11A, Over voltage protection- 29V max automatic shutdown
	Connector	3 pin/grounded, mates w	ith interchangeable cords
	Environmental Design	Operating temperature	32° to 104° F (0° to 40° C)
		Non-operating (storage) temperature	-4° to 149° F (-20° to 65° C)
		Altitude	0 to 10,000 ft (0 to 3,048 m)
		Humidity	20% to 80%
		Storage Humidity	10% to 90%
	EMI and Safety Certifications	standards – IEC60950, E approvals – C-UL-US, NC	e with LVD and EMC directives; Worldwide safety N60950, UL60950, Class1, SELV; Agency DRDICS, DENAN, EN55022 Class B, FCC Class B NOM-1 NYCE; MTBF– over 200,000 hours at
	Option Kit Contents	90W AC Adapter, power	cable, warranty booklet
Optional HP 12-Cell	Dimensions (H \times W \times L)	1.3 x 6.0 x 10.6 in (3.33	x 15.25 x 26.88 cm)
Ultra-Capacity Battery	Weight	1.77 lb (0.803 kg)	
	Cells/Type	12-cell Lithium-Ion	
	Energy	Voltage	14.8V
		Watt-hour Capacity	95Wh
		Amp-hour Capacity	6.45Ah
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging)	14° to 140° F (–10° to 60° C)
		Non-operating	–4° to 140° F (–20° to 60° C)
	Battery Re-Charge Time	Smart Adapter	3 to 4 hours
		System ON	4 to 5 hours (depending on system power consumption)
	Fuel Gauge	When pressed, LEDs light indicating level of charge remaining on battery	



Technical Specificat	lions			
Optional HP 8-Cell Extended Life Battery	Dimensions (H x W x L) Weight Cells/Type	1.0 x 3.9 x 8.7 in (2.5 x 10.0 x 22.0 cm) 1.00 lb (0.455 kg) 8-cell Lithium-Ion		
	Energy	Voltage	14.4V	
	Lineigy	Watt-hour Capacity	52Wh	
		Amp-hour Capacity	3.6Ah	
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)	
	romporatoro	Operating (Discharging)	14° to 140° F (–10° to 60° C)	
		Non-operating	-4° to 140° F (-20° to 60° C)	
	Battery Re-Charge Time	System in OFF mode or Standby	3 hours	
		System ON	3 to 5 hours (depending on system power consumption)	
		HP Fast Charge Technology	Charges the battery up to 90% within 90 minutes when system is OFF	
	Fuel Gauge	When pressed, LEDs light indicating level of charge remaining on battery		
69Wh Primary 8-Cell	Dimensions (H $x $ W $x $ L)	0.8 x 1.9 x 10.6 in (2.0 x 4.8 x 27.0 cm)		
, Battery	Weight	0.980 lb (0.445 kg)	,	
	Cells/Type	8-cell Lithium-Ion		
	Energy	Voltage	14.4V	
		Watt-hour Capacity	69Wh	
		Amp-hour Capacity	4.8Ah	
	Temperature	Operating (Charging)	32° to 113° F (0° to 45° C)	
		Operating (Discharging)	14° to 140° F (–10° to 60° C)	
		Non-operating	–4° to 140° F (–20° to 60° C)	
	Battery Re-Charge Time	System in OFF mode or Standby	2.5 hours	
		System ON	3 to 5 hours (depending on system power consumption)	
		HP Fast Charge Technology	Charges the battery up to 90% within 90 minutes when system is OFF	



Technical Specification	ons			
17.0-Inch Color TFT	Active Area (W x H)	14.5 x 9.0 in (36.7 x	22.9 cm)	
WXGA+ Display	Diagonal Size	17.0 in (431.8 mm)		
	Surface Treatment	Anti-glare		
	Number of Colors	Up to 16M		
	Contrast Ratio	300:1 typical		
	Refresh Rate	60 Hz		
	Brightness	150 nit typical		
	Pixel Resolution	Pitch	0.255 mm	
		Format	1440 x 900	
		Configuration	RGB Stripe	
	Backlight	CCFL		
	PPI	100		
	Viewing Angle	$\pm 45^{\circ}$ Horizontal, ± 2	25° Vertical (typical)	
17.0-Inch Color TFT	Active Area (W × H)	14.5 x 9.0 in (36.7 x	22.9 cm)	
WSXGA+ Wide Viewing	Diagonal Size	17.0 in (43.2 cm)		
Angle Display	Surface Treatment	Anti-glare		
	Number of Colors	Up to 16M		
	Contrast Ratio	300:1 typical		
	Refresh Rate	60 Hz		
	Brightness	170 nit typical		
	Pixel Resolution	Pitch	0.219 mm	
		Format	1680 x 1050	
		Configuration	RGB Stripe	
	Backlight	CCFL		
	PPI	116		
	Viewing Angle	$\pm 75^{\circ}$ Horizontal, ± 6	50° Vertical (typical)	
17.0-Inch Color TFT	Active Area (W × H)	14.5 x 9.0 in (36.7 x	22.9 cm)	
WSXGA+ Wide Viewing	Diagonal Size	17.0 in (43.2 cm)		
Angle BrightView Display	Surface Treatment	BrightView		
	Number of Colors	Up to 16M		
	Contrast Ratio	300:1 typical		
	Refresh Rate	60 Hz		
	Brightness	170 nit typical		
	Pixel Resolution	Pitch	0.219 mm	
		Format	1680 x 1050	
		Configuration	RGB Stripe	
	Backlight	CCFL		
	PPI	116		
	Viewing Angle	$\pm70^{\circ}$ Horizontal, ±6	60° Vertical (typical)	



Technical Specifications

Hard Drives

120-GB 5400 rpm SATA	Drive Weight	0.25 lb (113 g)	
	Capacity	120 GB	
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-7 / SATA 1.0a	
	Transfer Rate	Synchronous (maximum)	100 MB/s (Drive Capability)
	Seek Time	Single Track	3 ms
	(typical reads, including	Average	12 ms
	settling)	Maximum	24 ms
	Rotational Speed	5400 rpm	
	Logical Blocks	234,441,648	
	Operating Temperature	41° to 140° F (5° to 60° C	C) [case temp]
	Features	ATA Security	
100-GB 5400 rpm SATA	Drive Weight	0.22 lb (101 g)	
	Capacity	100 GB	
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-7 / SATA 1.0a	
	Transfer Rate	Synchronous (maximum)	100 MB/s (Drive Capability)
	Seek Time	Single Track	3 ms
	(typical reads, including	Average	13 ms
	settling)	Maximum	24 ms
	Rotational Speed	5400 rpm	
	Logical Blocks	195,371,568	
	Operating Temperature	41° to 140° F (5° to 60° C	C) [case temp]
	Features	ATA Security	



Technical Specifications

80-GB 5400 rpm SATA	Drive Weight	0.22 lb (101 g)	
· ·	Capacity	80 GB	
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-7 / SATA 1.0a	
	Transfer Rate	Synchronous (maximum)	100 MB/s (Drive Capability)
	Seek Time	Single Track	3 ms
	(typical reads, including	Average	13 ms
	settling)	Maximum	24 ms
	Rotational Speed	5400 rpm	
	Logical Blocks	156,301,488	
	Operating Temperature	41° to 140° F (5° to 60° C) [case temp]	
	Features	ATA Security	
60-GB 5400 rpm SATA	Drive Weight	0.22 lb (101 g)	
	Capacity	60 GB	
	Height	0.37 in (9.5 mm)	
	Width	2.75 in (70 mm)	
	Interface	ATA-7 / SATA 1.0a	
	Transfer Rate	Synchronous (maximum)	100 MB/s (Drive Capability)
	Seek Time	Single Track	3 ms
	(typical reads, including	Average	13 ms
	settling)	Maximum	24 ms
	Rotational Speed	5400 rpm	
	Logical Blocks	117,231,408	
	Operating Temperature	41° to 140° F (5° to 60° 0	C) [case temp]
	Features	ATA Security	

Removable Storage Drives – Fixed Bay



rechnical specificali	0115		
DVD/CD-RW Combo Drive	Access Times	Random	<110 ms CD <130 ms DVD
	Max Data Transfer Rate	24X CD-ROM	3,600 KB/s
		8X DVD	10,800 KB/s
		24X CD-R	3,600 KB/s
		24X CD-RW	3,600 KB/s
	Transfer Mode	Multiword DMA Mode 2	5,000 KB/S
	Interface	EIDE	
	Supported Media (read)	CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD- ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R, DVD+RW	
	Supported Media (write)	CD-R, CD-RW	
	Max Media Capacity (read)	8.5 GB	
	Max Media Capacity (write)	700 MB	
	Transport	Tray loading	
LightScribe DVD+/-RW Drive with Double Layer	Access Times	Random	<175 ms CD <230 ms DVD
	Max Data Transfer Rate	24X CD-ROM	3,600 KB/s
		8X DVD	10,800 KB/s
		24X CD-R	3,600 KB/s
		16X CD-RW	2,400 KB/s
		8X DVD+R	10,800 KB/s
		4X DVD+RW	5,400 KB/s
		8X DVD-R	10,800 KB/s
		4X DVD-RW	5,400 KB/s
		2.4X DVD+R(9)	2,700 KB/s
	Transfer Mode	Multiword DMA Mode 2	
	Interface	EIDE	
	Supported Media (read)	CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD- ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R, DVD+RW, LightScribe	
	Supported Media (write)	CD-R, CD-RW, DVD+R, DVD+RW, DVD-R, DVD-RW	
	Max Media Capacity (read)	8.5 GB	
	Max Media Capacity (write)	8.5 GB	
	Transport	Tray Loading	



Technical Specification	ons		
DVD+/-RW SuperMulti	Access Times	Random	<175 ms CD
Drive with Double Layer			<230 ms DVD
	Max Data Transfer Rate	24X CD-ROM	3,600 KB/s
		8X DVD	10,800 KB/s
		24X CD-R	3,600 KB/s
		16X CD-RW	2,400 KB/s
		8X DVD+R	10,800 KB/s
		4X DVD+RW	5,400 KB/s
		8X DVD-R	10,800 KB/s
		4X DVD-RW	5,400 KB/s
		2.4X DVD+R(9)	2,700 KB/s
		5X DVD-RAM	6,750 KB/s
	Transfer Mode	Multiword DMA Mode	
	Interface	EIDE	
	Supported Media (read)	CD-DA, CD+(E)G, CD-MIDI, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD- ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R, DVD+RW. DVD-RAM	
	Supported Media (write)	CD-R, CD-RW, DVD+R, [DVD+RW, DVD-R, DVD-RW, DVD-RAM
	Max Media Capacity (read)	8.5 GB	
	Max Media Capacity (write)	8.5 GB	
	Transport	Tray Loading	
HP Biometric Fingerprint Sensor (optional)	Mobile Voltage Operation	3.0V–3.6V Single Supply	
	Operating Temperature	32° – 158°F (0° – 70°C)	
	Current Consumption @ 3.3V	Less than 70 mA peak ima Less than 25 mA hardware Advanced Power Manager	e finger detection
	High-Rate Image Capture	Up to 240 image frames /	/sec
	ESD Resistance	IEC 61000-4-2 Level 4 (±	=15KV)
	Detection Matrix	192 x 16 Pixels 9.7 mm x 0.81 mm 500 ppi High-Resolution I	mages

Audio



I		
Hardware	Implementation	ADI1981HD High Definition CODEC
	Volume Controls	Up, down, and mute buttons
	Full Duplex	Yes
	Sound Blaster Pro compatible	Yes
	Microphone Jack	Stereo or mono
	Headphone/Line Out Jack	Stereo
Audio Output Quality	Frequency Response	20 Hz – 20 kHz
	Signal to Noise Ratio	>85 dB
	Total Harmonic Distortion	0.01%
	Noise Floor	-110 dB
	Play/Record Sampling Rate(s)	8 kHz – 48 kHz
	DAC	16, 20 or 24-bit
	ADC	16 or 20-bit
Internal Speakers	Power Rating	2 Watts
	Impedance	4 Ohms
Communications		
Integrated Broadcom NetXtreme Gigabit Ethernet PCI Express Controller (BCM5753M)	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3z and 802.3ab; IEEE 802.3 clauses 34-42) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s IEEE 802.1p QoS (Quality of Service) Support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)
	Power Management	ACPI compliant multiple power modes Situation-sensitive features reduce power consumption NIC Battery Saving Mode (enabled by default)
	Performance Features	TCP/IP/UDP Checksum Offload (configurable) TCP Segmentation Offload CPU Task Offload Adaptive Interrupts



Technical Specifica	itions	
	Manageability	Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Cable Analyzer
	Interface	PCI Express x1
	NIC Device Driver Name	
	Drivers Available	Microsoft Windows XP Microsoft Windows 2000
V.92 56K Data/Fax	Form Factor	MDC 1.5 Daughtercard
Modem	Power Management Support	APM Revision 1.2, ACPI
	Approvals/ Certifications	UL, CSA, NEMKO, CCIB, Industry Canada, FCC Part 68, CTR21, FCC Part 15 Class B, Canadian ICES-003 Class B, C.I.S.P.R.22, Australian ACA, CE Mark, Other Countries
	Data Mode Capabilities	V.92 data
		V.8bis
		V.80
		V44, V.42bis, MNP5 (Compression)
		V.42 (LAPM, MNP2-4) (Error Correction)
		Optional symbol rates: 2800, 3429 Asymmetric Symbol rates
		Synchronous primary channel data signaling rates: 3600, 31200 Automatic rate re-negotiation V.34 V.32bis V.32 V.23 V.22bis V.22 V.21 Bell 212A Bell 103J
	Fax Mode Capabilities	TIA/EIA-578-B (Class 1) T.30, T.4 (Group 3) V.17 V.29 V.27ter V.21 Channel 2



Technical Specifica	tions			
	Command Set	V.250 (Partial) TIA-602 Identification: +GMI, +G Port control: +IPR, +ICF, Modulation: +MS, +MR, Error control: +ES, +ER, Data compression: +DS, V.251	+IFC, +ILRR +MA +EB, +ESR, +ETBM	
Broadcom 4311AG 802.11a/b/g WiFi Adapter	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g		
	Interoperability	Wi-Fi certified Cisco Compatible Extensi (details at www.hp.com/g		
	Frequency Band	2.4 GHz and 5 GHz		
	Data Rates	802.11b: 1, 2, 5.5, 11 M 802.11a/g: 6, 9, 12, 18,		
	Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM		
	Security ¹		HWEP, WPA, WPA2, hardware-accelerated AES, bes EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP- AST, EAP-SIM.	
			/ Features (proven compatibility with Cisco Aironet ough the Cisco Compatible Extensions Program	
	Sub-channels	Multinational support with frequency bands and channels compliant to loc regulations.		
	Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK		
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)		
	Roaming	IEEE 802.11 compliant roaming between access points		
	Output Power (for CKK) ²	17.5 dBm		
	Output Power (for OFDM power varies by data rate) ²	; 15 dBm		
	Power Consumption	Transmit: 2.0 W (max) Receive: 1.5 W (max) Idle mode ³ : 390 mW (no Sleep mode: 20 mW (max)		
	Power Management	ACPI compliant power management 802.11 compliant power saving mode		
	Receiver Sensitivity ⁴	54 Mbps: -72 dBm, 11 N	1bps: -88 dBm , 1 Mbps: -97 dBm	
	Antenna type	High efficiency dual band display enclosure	antenna with spatial diversity, mounted in the	
	Range	802.11 a – Typical (@6 Mbps)	600 feet – Outdoor Open Area 150 feet – Indoor, Office environment	



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	802.11 b – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment	
	802.11 g – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment	
Form Factor	PCI-Express MiniCard		
Weight	0.026 lb (12 g)		
Dimensions	0.19 x 1.2 x 2.0 in (4.75 x	x 29.85 x 50.8 mm)	
Operating Voltage	3.3v +/- 10%		
Temperature	Operating Non-operating	32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)	
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
Configuration Utility ⁵	Choice of Configuration Utility:		
		XP Wireless Network Connection Manager Configuration Utility (required for Cisco ons support)	
LED Activity	LED Off – Radio OFF; Solid LED On – Radio ON		
 Check latest software/driver release for updates on supported security features. Maximum output power may vary by country according to local regulations. In Power Save Polling mode. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a 			
the second se	or rate of 10% for 802.11a/g (OFDM modulation). pplier's client utility is required for Cisco Compatible Extensions support. WLAN may also		

5. WLAN supplier's client utility is required for Cisco Compatible Extensions support. WLAN may be compatible with certain third-party software supplicants.

Broadcom 4311BG 802.11b/g WiFi Adapter	Wireless LAN Standards	IEEE 802.11b IEEE 802.11g
	Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant (details at <u>www.hp.com/go/notebooks/WLAN</u>)
	Frequency Band	2.4 GHz
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM
	Security ¹	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, LEAP, EAP-FAST, EAP-SIM.
		Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4).
	Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.
	Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK



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Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)	
Roaming	IEEE 802.11 compliant roaming between access points	
Output Power (for CKK) ²	17.5 dBm	.
Output Power (for OFDM power varies by data rate) ²	; 15 dBm	
Power Consumption	Transmit: 2.0 W (max) Receive: 1.5 W (max) Idle mode ³ : 390 mW (nor Sleep mode: 20 mW (max	
Power Management	ACPI compliant power ma 802.11 compliant power s	•
Receiver Sensitivity ⁴	54 Mbps: -72 dBm, 11 M	bps: -88 dBm , 1 Mbps: -97 dBm
Antenna type	High efficiency dual band display enclosure	antenna with spatial diversity, mounted in the
Range	802.11 b – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment
	802.11 g – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment
Form Factor	PCI-Express MiniCard	
Weight	0.026 lb (12 g)	
Dimensions	0.19 x 1.2 x 2.0 in (4.75 x	x 29.85 x 50.8 mm)
Operating Voltage	3.3v +/- 10%	
Temperature	Operating Non-operating	32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
Configuration Utility ⁵	Choice of Configuration L	Itility:
 Microsoft Windows XP Wireless Network Connection Manager Broadcom Wireless Configuration Utility (required for Cisco Compatible Extensions support) 		
LED Activity	LED Off – Radio OFF; Sol	id LED On – Radio ON
 Check latest software/driver release for updates on supported security features. Maximum output power may vary by country according to local regulations. In Power Save Polling mode. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation). WLAN supplier's client utility is required for Cisco Compatible Extensions support. WLAN may also be compatible with certain third-party software supplicants. 		

Intel PRO/Wireless 3945ABG 802.11a/b/g Network Connection

Wireless LAN Standards	IEEE 802.11a
	IEEE 802.11b
	IEEE 802.11g



Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant (details at www.hp.com/go/notebooks/WLAN)			
Frequency Band	2.4 GHz and 5 GHz			
Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps			
Modulation	Direct Sequence Spread S DBPSK, DQPSK, CCK, OF			
Security ¹		WEP, WPA, WPA2, hardware-accelerated AES, es EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP- AST, EAP-SIM.		
		Features (proven compatibility with Cisco Aironet ough the Cisco Compatible Extensions Program		
Sub-channels	Multinational support with regulations.	frequency bands and channels compliant to local		
Media Access Protocol	CSMA/CA (Collision Avoid	dance) with ACK		
Network Architecture	Ad-hoc (Peer to Peer)			
Models	Infrastructure (Access Poin			
Roaming	•	aming between access points		
		15 dBm		
Output Power (for OFDM power varies by data rate) ²	; 15 dBm			
Power Consumption	Transmit: 1.8 Watts (max) Receive: 1.4 Watts (max) Idle mode ³ : 150 mW (nominal) Sleep mode: 30 mW (max)			
Power Management	ACPI compliant power management 802.11 compliant power saving mode			
Receiver Sensitivity ⁴	54 Mbps: -72 dBm, 11 M	bps: -88 dBm , 1 Mbps: -97 dBm		
Antenna type	High efficiency dual band display enclosure	antenna with spatial diversity, mounted in the		
Range	802.11 a – Typical (@6 Mbps)	600 feet – Outdoor Open Area 150 feet – Indoor, Office environment		
	802.11 b – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment		
	802.11 g – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment		
Form Factor	PCI-Express MiniCard			
Weight	0.013 lb (6 g)			
Dimensions	0.19 x 1.2 x 2.0 in (4.75 x 29.85 x 50.8 mm)			
Operating Voltage	3.3v +/- 10%			
Temperature	Operating Non-operating	32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)		
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)		



HP Compaq nx9420 Notebook PC

Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
Configuration Utility ⁵	Choice of Configuration l	Jtility:
LED Activity		XP Wireless Network Connection Manager red for Cisco Compatible Extensions support) id LED On – Radio ON
 Maximum output p In Power Save Polli Receiver sensitivity packet error rate of WLAN supplier's cli 	ftware/driver release for updates on supported security features. ut power may vary by country according to local regulations.	

Intel PRO/Wireless 3945BG 802.11b/g Network Connection	Wireless LAN Standards	IEEE 802.11b IEEE 802.11g
	Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant (details at <u>www.hp.com/go/notebooks/WLAN</u>)
	Frequency Band	2.4 GHz
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM
	Security ¹	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, LEAP, EAP-FAST, EAP-SIM.
		Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4).
	Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.
	Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power (for CKK) ²	15 dBm
	Output Power (for OFDM) power varies by data rate) ²	; 15 dBm
	Power Consumption	Transmit: 1.8 Watts (max) Receive: 1.4 Watts (max) Idle mode ³ : 150 mW (nominal) Sleep mode: 30 mW (max)
	Power Management	ACPI compliant power management 802.11 compliant power saving mode
	Receiver Sensitivity ⁴	54 Mbps: -72 dBm, 11 Mbps: -88 dBm , 1 Mbps: -97 dBm



Antenna type

High efficiency dual band antenna with spatial diversity, mounted in the

Technical Specifications

		display enclosure		
	Range	802.11 b – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment	
		802.11 g – Typical (@1 Mbps)	1200 feet – Outdoor Open Area 300 feet – Indoor, Office environment	
	Form Factor	PCI-Express MiniCard		
	Weight	0.013 lb (6 g)		
	Dimensions	0.19 x 1.2 x 2.0 in (4.75 x 29.85 x 50.8 mm)		
	Operating Voltage	3.3v +/- 10%		
	Temperature	Operating Non-operating	32° to 176° F (0° to 80° C) -40° to 176° F (-40° to 80° C)	
	Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)	
	Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
	Configuration Utility ⁵	Choice of Configuratio	n Utility:	
			ws XP Wireless Network Connection Manager quired for Cisco Compatible Extensions support)	
	LED Activity	LED Off - Radio OFF;	Solid LED On – Radio ON	
	packet error rate o 5. WLAN supplier's cl	is measured at a packet e f 10% for 802.11a/g (OF	Cisco Compatible Extensions support. WLAN may also	
HP Integrated Module	Bluetooth Specification	2.0 Compliant		
with Bluetooth Wireless Technology	Dimensions	1.02 x 0.55 x 0.22 in	(26 x 14 x 5.7 mm)	
recimology	Frequency Band	2402 to 2480 MHz		
	Number of Available Channels	79 (1 MHz) available c	hannels	
	Data Rates and	3 Mbps data rate; thro	3 Mbps data rate; throughput up to 2.17 Mbps	
	Throughput	Synchronous Connection Oriented links up to 3, 64 kbps, voice channels		
		Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or 1306.9 kbps symmetric		
	Transmit Power	-6 dBm to 4 dBm (Bluetooth Class II)		
	Receiver Sensitivity	Better than -80 dBM at	0.1 % raw bit error rate	
	Power Consumption	Peak (Tx) 264 mW		
		Peak (Rx) 231 mW		
		Sleep <1 mW		
	Antenna	Internally integrated wi	thin module	
	Range	Up 33 ft (10 m)		
	Electrical Interface	USB 2.0 compliant		
		I.		



	Microsoft Windows Pl	ug and Play compliant		
OS Support	Microsoft Windows Plug and Play compliant Microsoft Windows XP Professional and Home			
03 300001	Microsoft Windows 2000			
Bluetooth Software	Broadcom Bluetooth for Windows			
Supported	Microsoft Windows XF			
Link Topology		bint Pico Nets up to 7 slaves		
Security	•	oth Security Provisions		
Power Management		CPI, and USB Bus Support		
r ower managemeni				
	including Standby, Ho	ptimize power conservation in all operating modes, old, Park, and Sniff		
Certifications	All necessary regulate	ry approvals for supported countries, including:		
	FCC (47 CFR) Part 15	5C, Section 15.247 & 15.249		
	ETS 300 328, ETS 30	0 826		
	Low Voltage Directive	IEC950		
	UL, CSA, and CE Ma	rk		
Temperature	Operating	-4° to 158° F (-20° to 70° C)		
	Non-operating	-40° to 176° F (-40° to 80° C)		
Humidity	Operating	10% to 90%		
	Non-operating	5% to 95%		
Altitude	Operating	15,000 ft (4,572 m)		
	Non-operating	40,000 ft (12,192 m)		
Bluetooth Profiles	(with Bluetooth for Windows 4.0 software)			
Supported	Serial Port Profile (SPF	P)*		
	Dial-Up Networking (DUN)*		
	Generic Object Excho	ange Profile (GOEP)		
	Object Push Profile (C	OPP)*		
	File Transfer Profile (FTP)			
	Synchronization Profile (SYNC)			
	Hard Copy Cable Replacement (HCRP)*			
	Personal Area Networking Profile (PAN)*			
	Human Interface Device Profile (HID)*			
	FAX Profile (FAX)			
	Basic Imaging Profile (BIP)			
	Headset Profile (HSP)	Headset Profile (HSP)		
	Hands Free Profile (H	FP)		
	Advanced Audio Distr	ibution Profile (A2DP)		
* indicates the profile is	also supported by Micros	oft Windows XP SP2		



I				
Environmental Data	Eco-Label Certifications	This product has received or following approvals and ma		
		 US Energy Star US Federal Energy Ma Taiwan Green Mark China Energy Conser IT ECO declaration 		(FEMP)
	System Configuration	The configuration used for the Emissions data is based on a		
	Energy Consumption	115 VAC	230 VAC	100 VAC
	Normal Operation	38.6 W	38.6 W	38.6 W
	Sleep (Energy Star low power mode)		3.5 W	3.7 W
	Off	1.45 W	1.45 W	1.45 W
	Heat Dissipation*	115 VAC	230 VAC	100 VAC
	Normal Operation	131 BTU/hr	131 BTU/hr	131 BTU/hr
	Sleep	12.6 BTU/hr	11.9 BTU/hr	12.6 BTU/hr
	Off	5 BTU/hr	5 BTU/hr	5 BTU/hr
		*NOTE: Heat dissipation is assuming the service level is		
		This product is in compliand on LAN) disabled.	ce with US executive c	order 13221, WOL (wake
	Declared Noise Emissions	Sound Power		Sound Pressure
	(in accordance with ISO 7779 and ISO 9296)	(LWAd, bels)		(LpAm, decibels)
	ldle	2.8		25.6
	Fixed Disk (random writes)	3.5		33.8
	Batteries	This product complies with I	SO standards:	
		EU Directive 91/ 157 EU Directive 93/ 86/ EU Directive 98/ 101	EEC	
		Batteries used in the product	t do not contain:	
		Mercury greater than Cadmium greater tha Lead greater than 400	in 10ppm by weight	
		Battery type and chemistry u	sed in the product:	
		Primary battery 8-cell high-capacity re	echargeable Lithium-I	on battery
		Real Time Clock batte CR2025 (coin cell), L		



Technical Specifico	ations	
	Additional Information	This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive – 2002/95/EC.
		This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
		Keyboard complies with ISO standard: ISO 9995, EN 29241-4, and ISO/IEC 15412
		Input devices of this product comply with ISO 9241, part 9.
		Plastics parts weighing over 0.055 pounds (25 grams) used in the product are marked per ISO 11469 and ISO1043.
		This product contains 0% recycled materials (by wt.)
		This product is greater than 85% recycle-able when properly disposed of at end of life.
	Packaging	Packaging Materials
		 External: Corrugated Paper – 1.27 lb (574 g) Internal: Corrugated Paper – 0.10 lb (45 g) PET Bag/Banding – 0.12 lb (56 g) The plastic packaging material is made from 20% recycled content. The corrugated paper packaging materials contains at least 80% recycled content.
		HP follows these guidelines to decrease the environmental impact of product packaging:
		 Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel

- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.



Technical Specifications

Material Usage This product does not contain any of the following substances in excess of regulatory limits (for reference of these limits please refer to the HP General Specification of the Environment (http://www.hp.com/hpinfo/globalcitizenship/environment/ supplychain/gen specifications.html): Asbestos • Certain Azo Colorants Certain Brominated Flame Retardants - may not be used as flame • retardants in plastics Cadmium • Chlorinated Hydrocarbons • **Chlorinated Paraffins** Formaldehyde • Halogenated Diphenyl Methanes Lead carbonates and sulfates Lead and Lead compounds Mercuric Oxide Batteries Nickel – finishes must not be used on the external surface designed to • be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyls (PBBs) Polybrominated Biphenyl Ethers (PBBEs) Polybrominated Biphenyl Oxides (PBBOs) Polychlorinated Biphenyl (PCB) Polychlorinated Terphenyls (PCT) Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. **Radioactive Substances** • Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO) End-of-life Management HP offers our customers several other options for handling their aging and Recycling computers while also minimizing the impact on the environment-including product trade-in and leasing services-in addition to recycling services. Please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. Hewlett-Packard For more information about HP's commitment to the environment: Corporate Environmental Global Citizenship Report Information http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Environment website http://www.hp.com/environment Eco-label certifications http://www.hp.com/hpinfo/globalcitizenship/environment/ productdesign/ecolabels.html ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/ operations/envmanagement.html



Technical Specifications

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